

RoHS

COMPLIANT

N-Channel 60 V (D-S) MOSFET

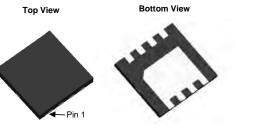
FEATURES

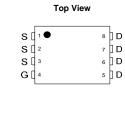
175 °C Junction Temperature
TrenchFET[®] Power MOSFET

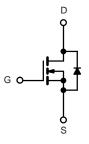
• Material categorization:

PRODUCT SUMMARY				
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a		
60	0.010 at V _{GS} = 10 V	15		
	0.013 at V _{GS} = 4.5 V	12		

DFN 3x3 EP







N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T_C =	= 25 °C, unless othe	rwise noted)		
Parameter	Symbol	Limit	Unit	
Gate-Source Voltage		V _{GS}	± 20	V
	T _C = 25 °C	1	15	
Continuous Drain Current (T _J = 175 °C) ^b	T _C = 100 °C	I _D	13 ^a	
Pulsed Drain Current	I _{DM}	100	А	
Continuous Source Current (Diode Conduction)	۱ _S	50 ^a		
Avalanche Current	I _{AS}	50		
Single Avalanche Energy (Duty Cycle \leq 1 %)	L = 0.1 mH	E _{AS}	125	mJ
Maximum Dawar Dissinction	T _C = 25 °C	P_	136	w
Maximum Power Dissipation	T _A = 25 °C	P _D	3 ^b , 8.3 ^{b, c}	vv
Operating Junction and Storage Temperature Range	·	T _J , T _{stg}	- 55 to 175	°C

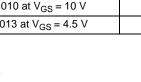
THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Marian and han to Amelian to	$t \le 10 \text{ sec}$	R _{thJA}	15	18		
Maximum Junction-to-Ambient ^a	Steady State		40	50	°C/W	
Maximum Junction-to-Case		R _{thJC}	0.85	1.1		

Notes:

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

c. $t \leq 10$ s.



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Parameter	Symbol	Test Conditions Min.		Typ. ^a	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA 60				V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1	2	3	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$			50	μA	
		$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$			250		
On-State Drain Current ^b	I _{D(on)}	$V_{DS} = 5 V, V_{GS} = 10 V$	60			Α	
		V _{GS} = 10 V, I _D = 20 A	0.010				
Dation Concerns to the state of the	P	V_{GS} = 10 V, I _D = 20 A, T _J = 125 °C		0.016			
Drain-Source On-State Resistance ^b	R _{DS(on)}	V_{GS} = 10 V, I _D = 20 A, T _J = 175 °C		0.020		Ω	
		V _{GS} = 4.5 V, I _D = 15 A		0.013			
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 20 A		60		S	
Dynamic			•	•			
Input Capacitance	C _{iss}			2650		pF	
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz		470			
Reverse Transfer Capacitance	C _{rss}			225		1	
Total Gate Charge ^c	Qg			47	70		
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 30 V, V_{GS} = 10 V, I_D = 50 A		10		nC	
Gate-Drain Charge ^c	Q _{gd}			12]	
Turn-On Delay Time ^c	t _{d(on)}			10	20		
Rise Time ^c	t _r	V_{DD} = 30 V, R_L = 0.6 Ω		15	25	nc	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 50$ A, V_{GEN} = 10 V, R_g = 2.5 Ω		35	50	ns	
Fall Time ^c	t _f			20	30		
Source-Drain Diode Ratings and Cha	racteristics (T _C = 25 °C)		·	·		
Pulsed Current	I _{SM}				60	А	
Diode Forward Voltage	V _{SD}	$I_{F} = 20 \text{ A}, V_{GS} = 0 \text{ V}$		1	1.5	V	
Reverse Recovery Time	t _{rr}	I _E = 20 A, di/dt = 100 A/µs		45	100	ns	

Notes:

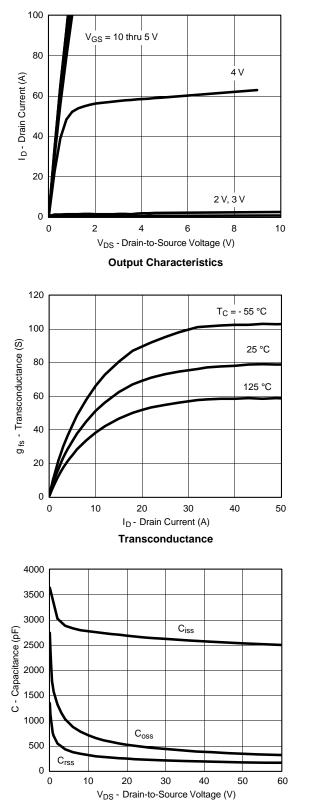
a. For design aid only; not subject to production testing.

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

c. Independent of operating temperature.

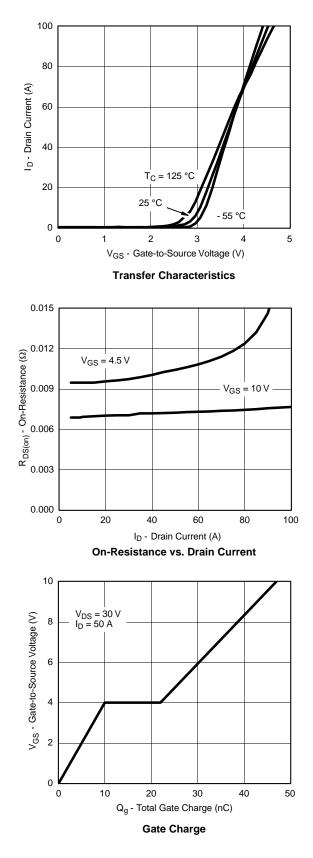
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



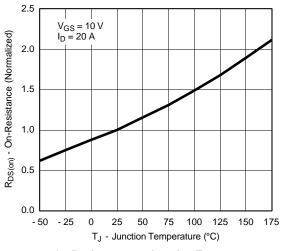


TYPICAL CHARACTERISTICS (25 °C unless noted)

Capacitance

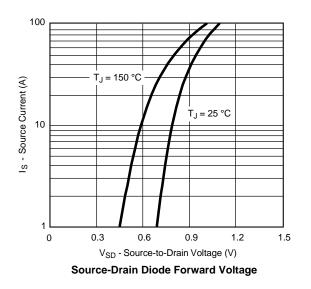






TYPICAL CHARACTERISTICS (25 °C unless noted)

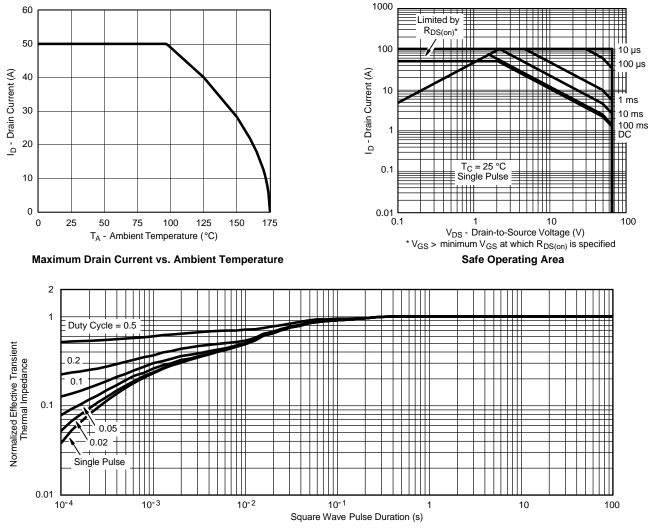
On-Resistance vs. Junction Temperature



SI7414DN

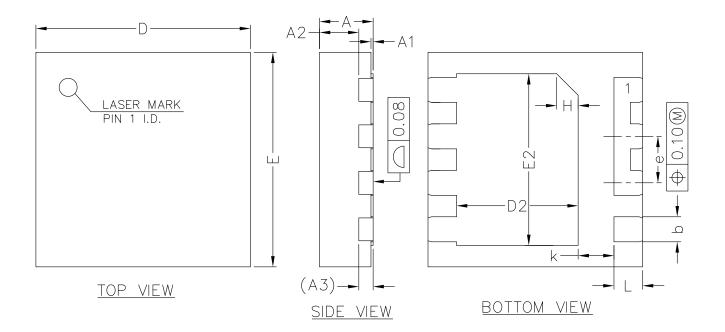


THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case







<u>SIDE VIEW</u>

SYMBOL	MIN	NOM	MAX	
А	0.70	0.75	0.80	
A1	0.00	0.02	0.05	
A2	0.50	0.55	0.60	
A3	0.20REF			
b	0.30	0.35	0.40	
D	2.90	3.00	3.10	
E	2.90	3.00	3.10	
D2	1.60	1.70	1.80	
E2	2.30	2.40	2.50	
е	0.55	0.65	0.75	
К	0.40	0.50	0.60	
L	0.35	0.40	0.45	

COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)



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